| Electronic Patent Application Fee Transmittal | | | | | | | |
|---|--|----------|--------|-------------------------|--|--|--|
| Application Number: | 10537509 | | | | | | |
| Filing Date: | 30-Nov-2005 | | | | | | |
| Title of Invention: | METHOD FOR CUTTING SEMICONDUCTOR SUBSTRATE | | | | | | |
| First Named Inventor/Applicant Name: | Fumitsugu Fukuyo | | | | | | |
| Filer: | John G. Smith/Traci Thompson | | | | | | |
| Attorney Docket Number: | 46884-5388 (211285) | | | | | | |
| Filed as Large Entity | • | | | | | | |
| U.S. National Stage under 35 USC 371 Filing | Fees | | | | | | |
| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | | |
| Basic Filing: | ' | | | | | | |
| Pages: | | | | | | | |
| Claims: | | | | | | | |
| Miscellaneous-Filing: | | | | | | | |
| Petition: | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | |
| Extension-of-Time: | | | | | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | | | |
|--|-------------------|----------|--------|-------------------------|--|--|--|--|
| Miscellaneous: | | | | | | | | |
| Submission-Information Disclosure Stmt | 1806 | 1 | 180 | 180 | | | | |
| | Total in USD (\$) | | | 180 | | | | |